Rs Gupta

List of Publications by Year in descending order

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331538 434063 1,253 52 21 31 citations h-index g-index papers 52 52 52 610 all docs docs citations times ranked citing authors

#	Article	IF	CITATIONS
1	Dielectric Modulated Triple Metal Gate All Around MOSFET (TMGAA)for DNA Bio-Molecule Detection., 2018,,.		13
2	Oxide Stack Engineered Double Surrounding Gate (OSE-DSG) MOSFET for Submillimeter Analog Application. , $2018, , .$		3
3	Ambipolarity reduction in DMG asymmetric vacuum dielectric Schottky Barrier GAA MOSFET to improve hot carrier reliability. Superlattices and Microstructures, 2017, 111, 10-22.	1.4	8
4	Sheet carrier concentration and threshold voltage modeling of asymmetrically doped AlGaN/GaN/AlGaN double heterostructure HEMT. , 2017, , .		7
5	Carrier concentration dependence of ballistic mobility and mean free path in a nano-dimensional InAlAs/InGaAs single gate HEMT. , 2016, , .		2
6	Investigation of Analog/RF performance of High-k spacer Junctionless Accumulation-Mode Cylindrical Gate All Around (JLAM-CGAA) MOSFET. , 2016, , .		2
7	GaN based Junctionless Double Surrounding Gate (JLDSG) MOSFET for high power, high voltage and high frequency applications. , 2016 , , .		3
8	AC analysis of Junctionless Double Surrounding Gate (JLDSG) MOSFET for Tera Hertz applications. , 2016, , .		0
9	Analytical modeling simulation and characterization of short channel Junctionless Accumulation Mode Surrounding Gate (JLAMSG) MOSFET for improved analog/RF performance. Superlattices and Microstructures, 2016, 100, 1263-1275.	1.4	13
10	Physics based analytical model for surface potential and subthreshold current of cylindrical Schottky Barrier gate all around MOSFET with high-k gate stack. Superlattices and Microstructures, 2016, 90, 215-226.	1.4	28
11	Asymmetrie Vacuum Gate Dielectric Schottky Barrier Gate all around MOSFET for ambipolarity reduction and improved hot carrier reliability. , 2015 , , .		2
12	Capacitance modeling of gate material engineered cylindrical/surrounded gate MOSFETs for sensor applications. Superlattices and Microstructures, 2015, 88, 271-280.	1.4	6
13	Impact of gate material engineering(GME) on analog/RF performance of nanowire Schottky-barrier gate all around (GAA) MOSFET for low power wireless applications: 3D T-CAD simulation. Microelectronics Journal, 2014, 45, 1508-1514.	1.1	73
14	An analytical subthreshold current modeling of cylindrical gate all around (CGAA) MOSFET incorporating the influence of device design engineering. Microelectronics Journal, 2014, 45, 408-415.	1.1	40
15	Drain current model for a gate all around (GAA) p–n–p–n tunnel FET. Microelectronics Journal, 2013, 44, 479-488.	1.1	49
16	Nano-modeling of the doping profiles for a symmetric double gate InAlAs/InGaAs/InP HEMT., 2012,,.		0
17	Impact of localised charges present in the interfacial layer of the schottky contact in SOI MESFET. , 2012, , .		O
18	Impact of noise temperature constant and diffusion coefficient on the minimum noise figure and minimum noise temperature of InAlAs/InGaAs DGHEMT. , 2012, , .		0

#	Article	IF	CITATIONS
19	Simulation of Enhanced Gate Control in a Double Gate Quantum Domain InAlAs/InGaAs/InP HEMT. , 2012, , .		О
20	An Accurate Small Signal Modeling of Cylindrical/Surrounded Gate MOSFET for High Frequency Applications. Journal of Semiconductor Technology and Science, 2012, 12, 377-387.	0.1	14
21	Laterally-asymmetric-channel-insulated-shallow-extension-silicon-on-nothing LAC-ISE-SON MOSFET for improved reliability and digital circuit simulation. , 2012, , .		О
22	An analytical drain current model for dual material engineered cylindrical/surrounded gate MOSFET. Microelectronics Journal, 2012, 43, 17-24.	1.1	71
23	Analytical Modeling and Simulation for Dual Metal Gate Stack Architecture (DMGSA) Cylindrical/Surrounded Gate MOSFET. Journal of Semiconductor Technology and Science, 2012, 12, 458-466.	0.1	24
24	Analysis and simulation of Si/GaAs/GaN MESFET to study the impact of localised charges on device performance. , 2011, , .		1
25	Laterally amalgamated DUal Material GAte Concave (L-DUMGAC) MOSFET for ULSI. Microelectronic Engineering, 2008, 85, 566-576.	1.1	25
26	Intermodulation distortion and linearity performance assessment of 50-nm gate length L-DUMGAC MOSFET for RFIC design. Superlattices and Microstructures, 2008, 44, 143-152.	1.4	27
27	Modeling and analysis of fully strained and partially relaxed lattice mismatched AlGaN/GaN HEMT for high temperature applications. Superlattices and Microstructures, 2008, 44, 781-793.	1.4	13
28	Two dimensional analytical modeling of multi-layered dielectric G ⁴ MOSFET-A novel design. , 2008, , .		0
29	Asymmetric Multilayered Gate Dielectric (AMGAD) surrounding gate MOSFET: A new structural concept for enhanced device performance., 2008,,.		O
30	Impact of laterally asymmetric channel and gate stack design on device performance of surrounding gate MOSFETs: A modeling and simulation study., 2008,,.		1
31	Gate Material Engineered-Trapizoidal Recessed Channel MOSFET (GME-TRC) for Ultra Large Scale Integration (ULSI)., 2008,,.		1
32	Capacitance modeling of 120nm AlGaN/GaN HEMT for microwave and high speed circuit applications. , 2008, , .		1
33	Asymmetric Gate Stack Surrounding gate Transistor (ASYMGAS SGT): 2-D Analytical Threshold Voltage Model. , 2007, , .		3
34	Impact of graded channel (GC) design in fully depleted cylindrical/surrounding gate MOSFET (FD) Tj ETQq0 0 0 2007, 51, 398-404.	rgBT /Over 0.8	lock 10 Tf 50 40
35	An analytical drain current model for graded channel cylindrical/surrounding gate MOSFET. Microelectronics Journal, 2007, 38, 352-359.	1.1	39
36	A compact C–V model for 120nm AlGaN/GaN HEMT with modified field dependent mobility for high frequency applications. Microelectronics Journal, 2007, 38, 848-854.	1.1	13

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37	Polarization dependent analysis of AlGaN/GaN HEMT for high power applications. Solid-State Electronics, 2007, 51, 130-135.	0.8	70
38	Modeling and simulation of a nanoscale three-region tri-material gate stack (TRIMGAS) MOSFET for improved carrier transport efficiency and reduced hot-electron effects. IEEE Transactions on Electron Devices, 2006, 53, 1623-1633.	1.6	45
39	Two-dimensional analytical threshold voltage model for DMG Epi-MOSFET. IEEE Transactions on Electron Devices, 2005, 52, 23-29.	1.6	19
40	Design considerations for novel device architecture: hetero-material double-gate (HEM-DG) MOSFET with sub-100 nm gate length. Solid-State Electronics, 2004, 48, 1169-1174.	0.8	25
41	Comprehensive analysis of small-signal parameters of fully strained and partially relaxed high Al-content lattice mismatched Al/sub m/Ga/sub 1-m/N/GaN HEMTs. IEEE Transactions on Microwave Theory and Techniques, 2003, 51, 607-617.	2.9	27
42	Physics-based analytical modeling of potential and electrical field distribution in dual material gate (DMG)-MOSFET for improved hot electron effect and carrier transport efficiency. IEEE Transactions on Electron Devices, 2002, 49, 1928-1938.	1.6	89
43	An accurate charge control model for spontaneous and piezoelectric polarization dependent two-dimensional electron gas sheet charge density of lattice-mismatched AlGaN/GaN HEMTs. Solid-State Electronics, 2002, 46, 621-630.	0.8	137
44	Design and optimization of thin film fully depleted vertical surrounding gate (VSG) MOSFETs for enhanced short channel immunity. Solid-State Electronics, 2002, 46, 1333-1338.	0.8	13
45	Impact of strain relaxation of AlmGa1â^'mN layer on 2-DEG sheet charge density and current voltage characteristics of lattice mismatched AlmGa1â^'mN/GaN HEMTs. Microelectronics Journal, 2002, 33, 205-212.	1.1	21
46	Analytical model for threshold voltage and I–V characteristics of fully depleted short channel cylindrical/surrounding gate MOSFET. Microelectronic Engineering, 2001, 56, 241-259.	1.1	79
47	An accurate 2D analytical model for short channel thin film fully depleted cylindrical/surrounding gate (CGT/SGT) MOSFET. Microelectronics Journal, 2001, 32, 305-313.	1.1	31
48	Two-dimensional C-V model of AlGaAs/GaAs modulation doped field effect transistor (MODFET) for high frequency applications. IEEE Transactions on Electron Devices, 1999, 46, 1818-1823.	1.6	18
49	Analytical two-dimensional modeling for potential distribution and threshold voltage of the short-channel fully depleted SOI (silicon-on-insulator) MOSFET. Solid-State Electronics, 1994, 37, 1537-1542.	0.8	19
50	Variable time step methods for one-dimensional stefan problem with mixed boundary condition. International Journal of Heat and Mass Transfer, 1981, 24, 251-259.	2.5	76
51	A modified variable time step method for the one-dimensional stefan problem. Computer Methods in Applied Mechanics and Engineering, 1980, 23, 101-109.	3.4	54
52	Applicability of Field Plate in Double Channel GaN HEMT for Radio-Frequency and Power-Electronic Applications. Silicon, 0, , 1.	1.8	8